

# Typical unit

#### **FEATURES**

- 12 Volts DC fixed output up to 25 Amps
- Industry standard quarter brick 2.3" x 1.45" x 0.49" open frame package
- Wide range 36 to 75 Vdc input voltages with 2250 Volt Basic isolation
- Double lead-free assembly and attachment for RoHS standards
- Up to 300 Watts total output power
- High efficiency (94.5%) synchronous rectifier topology
- Stable no-load operation with no required external components
- Operating temperature range -40 to +85° C. with no heat sink required
- Certified to UL/EN 60950-1, CSA-C22.2 No. 60950-1, 2nd edition safety approvals
- Extensive self-protection, current limiting and shut down features
- "X" optional version omits trim and sense pins

HPQ-12/25-D48 Series

Isolated 300-Watt Quarter Brick DC-DC Converters

Output (V)	Current (A)	Nominal Input (V)
12	25	48

#### **PRODUCT OVERVIEW**

The HPQ-12/25-D48 series offers high output current (up to 25 Amps) in an industry standard "quarter brick" package requiring no heat sink for most applications. The HPQ-12/25-D48 series delivers fixed 12 Vdc output at 300 Watts for printed circuit board mounting. Wide range inputs on the 2.3" x 1.45" x 0.49" converter are 36 to 75 Volts DC (48 Volts nominal), ideal for datacom and telecom systems. The fixed output voltage is regulated to within  $\pm 0.25\%$ .

Advanced automated surface mount assembly and planar magnetics deliver galvanic isolation rated at 2250 Vdc for basic insulation. To power digital systems, the outputs offer fast settling to current steps and tolerance of higher capacitive loads. Excellent ripple and noise specifications assure compatibility to CPU's, ASIC's, programmable logic and FPGA's. No minimum load is required. For systems needing controlled startup/shutdown, an

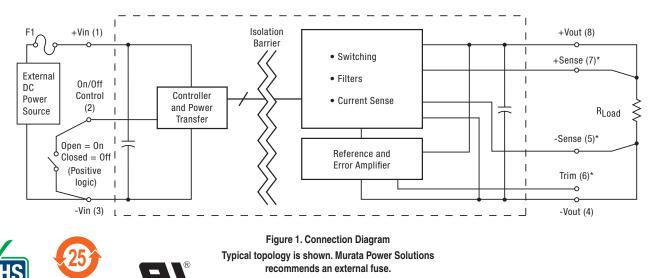
#### **APPLICATIONS**

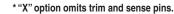
- Embedded systems, datacom and telecom installations
- Disk farms, data centers and cellular repeater sites
- Remote sensor systems, dedicated controllers

external remote On/Off control may use either positive or negative logic. Remote Sense inputs compensate for resistive line drops at high currents.

A wealth of self-protection features avoid problems with both the converter and external circuits. These include input undervoltage lockout and overtemperature shutdown using an on-board temperature sensor. Overcurrent protection using the "hiccup" autorestart technique provides indefinite short-circuit protection. Additional safety features include output overvoltage protection and reverse conduction elimination. The synchronous rectifier topology offers high efficiency for minimal heat buildup and "no heat sink" operation. The HPQ-12/25-D48 series is certified to full safety standards UL/EN/IEC/ CSA 60950-1, 2nd edition and RFI/EMI conducted/ radiated emission compliance to EN55022, CISPR22 with external filter.

- Instrumentation systems, R&D platforms, automated test fixtures
- Data concentrators, voice forwarding and speech processing systems





For full details go to

v.murata-ps.com/roh

## HPQ-12/25-D48 Series

Isolated 300-Watt Quarter Brick DC-DC Converters

PEFORMANCE SPECIFICATION SUMMARY AND ORDERING GUIDE ①																
				Outpu	t				In	put						
		Іоит		R/N pk-	•	Regulatio	n (Max.) @				lin full	Efficiency		Package (C59)		
Root Model ①	Vоит (Volts)		Power (Watts)	Тур.	Max.	Line	Load	VIN Nom. (Volts)	Range (Volts)	lın no load (mA)	load (Amps)	Min. 3	Тур.	Dimensions (inches)	Dimensions (mm)	
HPQ-12/25-D48	12	25	300	80	120	±0.125%	±0.25%	48	36-75	150	6.61	94%	95%	2.3x1.45x0.49 max.	58.4x36.8x12.45	

① Please refer to the part number structure for additional ordering information and options.
 ② All specifications are at nominal line voltage and full load, +25 deg.C. unless otherwise noted.

See detailed specifications. Output capacitors are 1 µF ceramic in parallel with 10 µF electrolytic

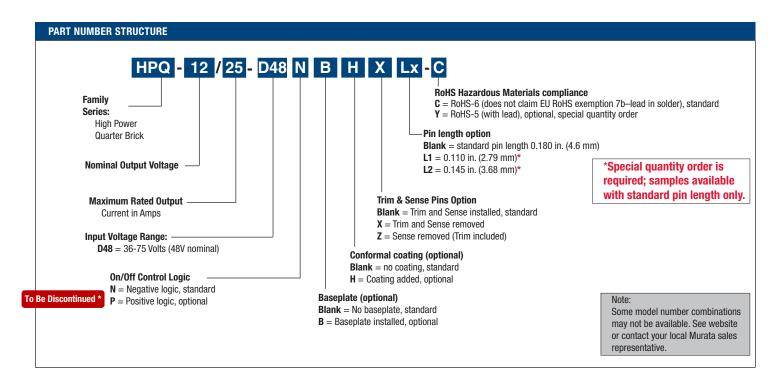
with no input caps. These caps are necessary for our test equipment and may not be needed for your application.

 $\$  Ta=25C, Vin=48V, Full load condition.



#### NOTE: The following products are To Be Discontinued.

HPQ-12/25-D48PB-C HPQ-12/25-D48PBX-C HPQ-12/25-D48PH-C HPQ-12/25-D48PBH-C HPQ-12/25-D48P-C HPQ-12/25-D48PX-C



Complete Model Number Example:



Negative On/Off logic, baseplate installed, conformally coated, trim and sense pins removed, 0.110" pin length, RoHS-6 compliance

www.murata-ps.com/support

MDC\_HPQ-12/25-D48 Series.B08 Page 2 of 16

\* Last Time Buy date is 3/31/2019. Please click here to view the Discontinuance Notification.

# HPQ-12/25-D48 Series

## Isolated 300-Watt Quarter Brick DC-DC Converters

#### **FUNCTIONAL SPECIFICATIONS**

ABSOLUTE MAXIMUM RATINGS	Conditions ①	Minimum	Typical/Nominal	Maximum	Units
nput Voltage, Continuous	Full power operation	36		80	Vdc
	Operating or non-operating,			100	
nput Voltage, Transient	100 mS max. duration			100	Vdc
solation Voltage	Input to output tested 100 mS			2250	Vdc
Input Reverse Polarity	None, install external fuse		None	2200	Vdc
On/Off Remote Control	Power on or off, referred to -Vin	0	None	13.5	Vdc
Output Power		0		300	W
ouputrowci	Current-limited, no damage,	0		500	**
Output Current		0		25	A
Stavaga Tampavatura Danga	short-circuit protected	-55		125	°C
Storage Temperature Range	Vin = Zero (no power)		r tarm raliability. Dranar ana		-
	e of devices to greater than any of these conditions ma	ay adversely affect long	g-term reliability. Proper oper	auon under conditions	other than tho
listed in the Performance/Functional Specification					
INPUT	Conditions ① ③				
Operating voltage range		36	48	75	Vdc
Recommended External Fuse	Fast blow		20		A
Start-up threshold	Rising input voltage	33	34	35	Vdc
Undervoltage shutdown	Falling input voltage	31	32	34	Vdc
Dvervoltage protection	Rising input voltage		None		Vdc
Reverse Polarity Protection	None, install external fuse		None		Vdc
Internal Filter Type			Pi-type		Vuc
Input current			Trype		1
Full Load Conditions	Vin = nominal		6.61	6.82	٨
			6.61		A
Low Line	Vin = minimum		8.82	9.1	A
Inrush Transient	Vin = 48V.		0.3		A2-Sec.
Output in Short Circuit			50	100	mA
No Load	lout = minimum, unit=ON		150	250	mA
Standby Mode (Off, UV, OT)			5	10	mA
Reflected (back) ripple current 2	Measured at input with specified filter		50	70	mA, RMS
GENERAL and SAFETY					
Efficiency	Vin=48V, full load	94	95		%
-	Vin=48V, full load	94	95		%
solation		94	95		% Vdc
Isolation Isolation Voltage, input to output	No baseplate	2250	95		Vdc
Isolation Isolation Voltage, input to output Isolation Voltage, input to output	No baseplate With baseplate	2250 2250	95		Vdc Vdc
Isolation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate	No baseplate With baseplate With baseplate	2250 2250 1500	95		Vdc Vdc Vdc
solation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate	No baseplate With baseplate	2250 2250			Vdc Vdc
solation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Insulation Safety Rating	No baseplate With baseplate With baseplate	2250 2250 1500 1500	95		Vdc Vdc Vdc Vdc
solation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Insulation Safety Rating Isolation Resistance	No baseplate With baseplate With baseplate	2250 2250 1500	basic		Vdc Vdc Vdc Vdc MΩ
Isolation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Insulation Safety Rating	No baseplate With baseplate With baseplate With baseplate	2250 2250 1500 1500			Vdc Vdc Vdc Vdc
Isolation Isolation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Insulation Safety Rating Isolation Resistance Isolation Capacitance	No baseplate With baseplate With baseplate With baseplate Certified to UL-60950-1, CSA-C22.2 No.60950-1,	2250 2250 1500 1500	basic		Vdc Vdc Vdc Vdc MΩ
Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Insulation Safety Rating Isolation Resistance	No baseplate With baseplate With baseplate With baseplate Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition	2250 2250 1500 1500	basic 1000		Vdc Vdc Vdc Vdc MΩ
Isolation Isolation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Insulation Safety Rating Isolation Resistance Isolation Capacitance Safety	No baseplate With baseplate With baseplate With baseplate Certified to UL-60950-1, CSA-C22.2 No.60950-1,	2250 2250 1500 1500	basic 1000 Yes		Vdc Vdc Vdc Vdc MΩ pF
Isolation Isolation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Insulation Safety Rating Isolation Resistance Isolation Capacitance	No baseplate With baseplate With baseplate With baseplate Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition	2250 2250 1500 1500	basic 1000		Vdc Vdc Vdc Vdc MΩ pF
Isolation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Insulation Safety Rating Isolation Resistance Isolation Capacitance Safety Calculated MTBF	No baseplate With baseplate With baseplate With baseplate With baseplate Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition Per MIL-HDBK-217F, ground benign,	2250 2250 1500 1500	basic 1000 Yes TBD		Vdc Vdc Vdc Vdc MΩ pF Hours x 10
solation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Insulation Safety Rating Isolation Resistance Isolation Capacitance Safety Calculated MTBF	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground	2250 2250 1500 1500	basic 1000 Yes		Vdc Vdc Vdc Vdc MΩ pF Hours x 10
solation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Insulation Safety Rating Isolation Resistance Isolation Capacitance Safety Calculated MTBF	No baseplate With baseplate With baseplate With baseplate Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C	2250 2250 1500 1500	basic 1000 Yes TBD		Vdc Vdc Vdc Vdc MΩ pF Hours x 10
Isolation Isolation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Isolation Safety Rating Isolation Resistance Isolation Capacitance Safety Calculated MTBF Calculated MTBF DYNAMIC CHARACTERISTICS	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground	2250 2250 1500 1500	basic 1000 Yes TBD 1500		Vdc Vdc Vdc Vdc MΩ pF Hours x 10 Hours x 10
Isolation Isolation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Isolation Safety Rating Isolation Resistance Isolation Capacitance Safety Calculated MTBF Calculated MTBF DYNAMIC CHARACTERISTICS	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground fixed, Tcase=+25°C	2250 2250 1500 1500	basic 1000 Yes TBD		Vdc Vdc Vdc Vdc MΩ pF Hours x 10
solation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Insulation Safety Rating Isolation Resistance Isolation Capacitance Safety Calculated MTBF Calculated MTBF DYNAMIC CHARACTERISTICS Fixed Switching Frequency	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground fixed, Tcase=+25°C         Power On, to Vout regulation band,	2250 2250 1500 1500	basic 1000 Yes TBD 1500	25	Vdc Vdc Vdc Vdc MΩ pF Hours x 10 Hours x 10
solation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Isolation Safety Rating Isolation Resistance Isolation Capacitance Safety Calculated MTBF Calculated MTBF DYNAMIC CHARACTERISTICS Fixed Switching Frequency Startup Time (2)	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground fixed, Tcase=+25°C         Power On, to Vout regulation band, 100% resistive load	2250 2250 1500 1500	basic 1000 Yes TBD 1500		Vdc Vdc Vdc Vdc MΩ pF Hours x 10 Hours x 10 KHz mS
solation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Isolation Safety Rating Isolation Resistance Isolation Capacitance Safety Calculated MTBF Calculated MTBF DYNAMIC CHARACTERISTICS Fixed Switching Frequency Startup Time (2)	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground fixed, Tcase=+25°C         Power On, to Vout regulation band, 100% resistive load         Remote ON to Vout Regulated	2250 2250 1500 1500	basic	25	Vdc Vdc Vdc Vdc MΩ pF Hours x 10 Hours x 10 Hours x 10 KHz mS
solation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Isolation Safety Rating Isolation Resistance Isolation Capacitance Safety Calculated MTBF DYNAMIC CHARACTERISTICS Fixed Switching Frequency Startup Time Dynamic Load Response	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground fixed, Tcase=+25°C         Power On, to Vout regulation band, 100% resistive load	2250 2250 1500 1500	basic 1000 Yes TBD 1500		Vdc Vdc Vdc Vdc MΩ pF Hours x 10 Hours x 10 KHz mS mS µSec
solation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Isolation Safety Rating Isolation Capacitance Safety Calculated MTBF DYNAMIC CHARACTERISTICS Fixed Switching Frequency Startup Time Startup Time Dynamic Load Response Dynamic Load di/dt	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground fixed, Tcase=+25°C         Power On, to Vout regulation band, 100% resistive load         Remote ON to Vout Regulated         50-75-50% load step to 1% error band	2250 2250 1500 1500	basic basic 1000 Yes TBD 1500 260 550	25 825 0.1	Vdc Vdc Vdc MΩ pF Hours x 1 Hours x 1 KHz MS μSec
solation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Isolation Safety Rating Isolation Capacitance Safety Calculated MTBF DYNAMIC CHARACTERISTICS Fixed Switching Frequency Startup Time Startup Time Dynamic Load Response Dynamic Load di/dt	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground fixed, Tcase=+25°C         Power On, to Vout regulation band, 100% resistive load         Remote ON to Vout Regulated	2250 2250 1500 1500	basic	25 825	Vdc Vdc Vdc MΩ pF Hours x 1 Hours x 1 KHz MS μSec
solation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Isolation Safety Rating Isolation Capacitance Safety Calculated MTBF DYNAMIC CHARACTERISTICS Fixed Switching Frequency Startup Time Startup Time Dynamic Load Response Dynamic Load di/dt	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground fixed, Tcase=+25°C         Power On, to Vout regulation band, 100% resistive load         Remote ON to Vout Regulated         50-75-50% load step to 1% error band	2250 2250 1500 1500	basic basic 1000 Yes TBD 1500 260 550	25 825 0.1	Vdc Vdc Vdc MΩ pF Hours x 1 Hours x 1 KHz MS MS μSec A / μSec
solation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Isolation Safety Rating Isolation Capacitance Safety Calculated MTBF DYNAMIC CHARACTERISTICS Fixed Switching Frequency Startup Time Startup Time Dynamic Load Response Dynamic Load Peak Deviation FEATURES and OPTIONS	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground fixed, Tcase=+25°C         Power On, to Vout regulation band, 100% resistive load         Remote ON to Vout Regulated         50-75-50% load step to 1% error band	2250 2250 1500 1500	basic basic 1000 Yes TBD 1500 260 550	25 825 0.1	Vdc Vdc Vdc Vdc MΩ pF Hours x 10 Hours x 10 KHz mS KHz mS μSec A / μSec
Isolation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Isolation Safety Rating Isolation Resistance Isolation Capacitance Safety Calculated MTBF DYNAMIC CHARACTERISTICS Fixed Switching Frequency Startup Time Dynamic Load Response Dynamic Load di/dt Dynamic Load Peak Deviation FEATURES and OPTIONS Remote On/Off Control @	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground fixed, Tcase=+25°C         Power On, to Vout regulation band, 100% resistive load         Remote ON to Vout Regulated         50-75-50% load step to 1% error band	2250 2250 1500 1500	basic basic 1000 Yes TBD 1500 260 550	25 825 0.1	Vdc Vdc Vdc MΩ pF Hours x 1 Hours x 1 KHz MS MS μSec A / μSec
Isolation Isolation Isolation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Isolation Safety Rating Isolation Capacitance Safety Calculated MTBF DYNAMIC CHARACTERISTICS Fixed Switching Frequency Startup Time Dynamic Load Response Dynamic Load di/dt Dynamic Load Peak Deviation FEATURES and OPTIONS Remote On/Off Control @ "N" suffix:	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground fixed, Tcase=+25°C         Power On, to Vout regulation band, 100% resistive load         Remote ON to Vout Regulated         50-75-50% load step to 1% error band         same as above	2250 2250 1500 1500 10	basic basic 1000 Yes TBD 1500 260 550	25 825 0.1 ±750	Vdc Vdc Vdc MΩ pF Hours x 10 Hours x 10 KHz mS MS μSec A / μSec mV
Isolation Isolation Isolation Isolation Voltage, input to output Isolation Voltage, input to output Isolation Voltage, input to baseplate Isolation Voltage, output to baseplate Isolation Safety Rating Isolation Capacitance Safety Calculated MTBF DYNAMIC CHARACTERISTICS Fixed Switching Frequency Startup Time Dynamic Load Response Dynamic Load di/dt Dynamic Load Peak Deviation FEATURES and OPTIONS Remote On/Off Control ④	No baseplate         With baseplate         With baseplate         With baseplate         With baseplate         With baseplate         Certified to UL-60950-1, CSA-C22.2 No.60950-1, IEC/EN60950-1, 2nd edition         Per MIL-HDBK-217F, ground benign, Tambient=+TBD°C         Per Telcordia SR-332, issue 1, class 3, ground fixed, Tcase=+25°C         Power On, to Vout regulation band, 100% resistive load         Remote ON to Vout Regulated         50-75-50% load step to 1% error band	2250 2250 1500 1500	basic basic 1000 Yes TBD 1500 260 550	25 825 0.1	Vdc Vdc Vdc MΩ pF Hours x 10 Hours x 10 KHz mS KHz mS μSec A / μSec

# HPQ-12/25-D48 Series

## Isolated 300-Watt Quarter Brick DC-DC Converters

#### **FUNCTIONAL SPECIFICATIONS (CONT.)**

FEATURES and OPTIONS (cont.)	Conditions ①	Minimum	Typical/Nominal	Maximum	Units
Remote On/Off Control (cont.) ④					
"P" suffix:					
Positive Logic, ON state	ON = pin open or external voltage	3.5		13.5	V
Positive Logic, OFF state	OFF = ground pin or external voltage	0		0.8	V
Control Current	open collector/drain			2	mA
	Vsense=Vout - Vload, Sense pins connected			0.5	N
Remote Sense Compliance ⑦	externally to respective Vout's			0.5	V
Base Plate	"B" suffix		optional		
OUTPUT			· ·		
Total Output Power		0.0	300	306	W
Voltage					I
Setting Accuracy	At 50% load, no trim	11.76	12	12.24	Vdc
Output Voltage Range ⑦	User-adjustable	-10		+10	% of Vnom.
Overvoltage Protection	Via magnetic feedback		14.4	18	V
Current	ha magnoto roodbaok			10	•
Output Current Range		0.0		25.0	А
Minimum Load		0.0	No minimum load	20.0	A
Current Limit Inception	98% of Vnom., after warmup	28.5	32	42	Α
Short Circuit		20.0	02	74	
	Hiccup technique, autorecovery within 1.25%				
Short Circuit Current			0.8	1.0	A
Short Circuit Duration	of Vout				
Short Circuit Duration	Output shorted to ground, no damage		Continuous		
(remove short for recovery)	Hippun aussant liss the s		Non latabir -		
Short circuit protection method	Hiccup current limiting		Non-latching		
Regulation (5)					
Line Regulation	Vin=min. to max., Vout=nom., full load			±0.125	% of Vout
Load Regulation	lout=min. to max., Vin=nom.			±0.25	% of Vout
Ripple and Noise ©	Vin=48V, full load, 5 Hz- 20 MHz BW, Cout=1µF		80	100	mV pk-pk
	MLCC paralleled with 10µF			100	пт рк рк
Temperature Coefficient	At all outputs		0.02		% of Vout./°C
Maximum Capacitive Loading	Full resistive load, low ESR	0		4,700	μF
MECHANICAL (Through Hole Models)					
Outline Dimensions (no baseplate)	C59 case		2.3x1.45x0.49 max.		Inches
(Please refer to outline drawing)	LxWxH		58.4x36.8x12.45		mm
Outline Dimensions (with baseplate)			2.3x1.45x0.5		Inches
			58.4x36.8x12.7		mm
			30.4730.0712.7		
Weight	No baseplate		1.51		Ounces
Weight	No baseplate No baseplate				_
Weight	No baseplate With baseplate		1.51		Ounces Grams Ounces
Weight	No baseplate		1.51 47		Ounces Grams
Weight Through Hole Pin Diameter	No baseplate With baseplate		1.51 47 2.4		Ounces Grams Ounces
Through Hole Pin Diameter	No baseplate With baseplate		1.51           47           2.4           68           0.04 & 0.062           1.016 & 1.575		Ounces Grams Ounces Grams
Through Hole Pin Diameter Through Hole Pin Material	No baseplate With baseplate		1.51           47           2.4           68           0.04 & 0.062           1.016 & 1.575           Copper alloy		Ounces Grams Ounces Grams Inches
Through Hole Pin Diameter	No baseplate         With baseplate         With baseplate         Nickel subplate		1.51           47           2.4           68           0.04 & 0.062           1.016 & 1.575           Copper alloy           100-299		Ounces Grams Ounces Grams Inches
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness	No baseplate With baseplate With baseplate		1.51           47           2.4           68           0.04 & 0.062           1.016 & 1.575           Copper alloy           100-299           3.9-19.6		Ounces Grams Ounces Grams Inches mm
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material	No baseplate         With baseplate         With baseplate         Nickel subplate		1.51           47           2.4           68           0.04 & 0.062           1.016 & 1.575           Copper alloy           100-299		Ounces Grams Ounces Grams Inches mm
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness	No baseplate         With baseplate         With baseplate         Nickel subplate		1.51           47           2.4           68           0.04 & 0.062           1.016 & 1.575           Copper alloy           100-299           3.9-19.6		Ounces Grams Ounces Grams Inches mm
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material	No baseplate         With baseplate         With baseplate         Nickel subplate	-40	1.51           47           2.4           68           0.04 & 0.062           1.016 & 1.575           Copper alloy           100-299           3.9-19.6	85	Ounces Grams Ounces Grams Inches mm µ-inches µ-inches
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material ENVIRONMENTAL	No baseplate         With baseplate         With baseplate         Nickel subplate         Gold overplate	<u>-40</u> -40	1.51           47           2.4           68           0.04 & 0.062           1.016 & 1.575           Copper alloy           100-299           3.9-19.6	<u>85</u> 110	Ounces Grams Ounces Grams Inches mm µ-inches µ-inches °C
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material ENVIRONMENTAL Operating Ambient Temperature Range Operating Case Temperature Storage Temperature	No baseplate         With baseplate         With baseplate         Nickel subplate         Gold overplate         See derating curves		1.51           47           2.4           68           0.04 & 0.062           1.016 & 1.575           Copper alloy           100-299           3.9-19.6		Ounces Grams Ounces Grams Inches mm µ-inches µ-inches °C °C °C
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material ENVIRONMENTAL Operating Ambient Temperature Range Operating Case Temperature	No baseplate         With baseplate         With baseplate         Nickel subplate         Gold overplate         See derating curves         No derating required	-40	1.51           47           2.4           68           0.04 & 0.062           1.016 & 1.575           Copper alloy           100-299           3.9-19.6	110	Ounces Grams Ounces Grams Inches mm µ-inches µ-inches °C
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material ENVIRONMENTAL Operating Ambient Temperature Range Operating Case Temperature Storage Temperature	No baseplate         With baseplate         With baseplate         Nickel subplate         Gold overplate         See derating curves         No derating required         Vin = Zero (no power)	-40 -55	1.51         47         2.4         68         0.04 & 0.062         1.016 & 1.575         Copper alloy         100-299         3.9-19.6         Aluminum	110 125	Ounces Grams Ounces Grams Inches mm µ-inches µ-inches °C °C °C
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material ENVIRONMENTAL Operating Ambient Temperature Range Operating Case Temperature Storage Temperature Thermal Protection/Shutdown	No baseplate         With baseplate         With baseplate         Nickel subplate         Gold overplate         See derating curves         No derating required         Vin = Zero (no power)         Measured at hotspot	-40 -55	1.51         47         2.4         68         0.04 & 0.062         1.016 & 1.575         Copper alloy         100-299         3.9-19.6         Aluminum	110 125	Ounces Grams Ounces Grams Inches mm µ-inches µ-inches °C °C °C
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material ENVIRONMENTAL Operating Ambient Temperature Range Operating Case Temperature Storage Temperature Thermal Protection/Shutdown Electromagnetic Interference	No baseplate         With baseplate         With baseplate         Nickel subplate         Gold overplate         See derating curves         No derating required         Vin = Zero (no power)         Measured at hotspot	-40 -55	1.51         47         2.4         68         0.04 & 0.062         1.016 & 1.575         Copper alloy         100-299         3.9-19.6         Aluminum         110	110 125	Ounces Grams Ounces Grams Inches mm µ-inches µ-inches °C °C °C °C
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material ENVIRONMENTAL Operating Ambient Temperature Range Operating Case Temperature Storage Temperature Thermal Protection/Shutdown Electromagnetic Interference Conducted, EN55022/CISPR22	No baseplate         With baseplate         With baseplate         Nickel subplate         Gold overplate         See derating curves         No derating required         Vin = Zero (no power)         Measured at hotspot	-40 -55	1.51         47         2.4         68         0.04 & 0.062         1.016 & 1.575         Copper alloy         100-299         3.9-19.6         Aluminum         110         B	110 125	Ounces Grams Ounces Grams Inches mm µ-inches µ-inches v-inches °C °C °C °C °C °C °C
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material ENVIRONMENTAL Operating Ambient Temperature Range Operating Case Temperature Storage Temperature Thermal Protection/Shutdown Electromagnetic Interference Conducted, EN55022/CISPR22 Radiated, EN55022/CISPR22	No baseplate         With baseplate         With baseplate         With baseplate         Nickel subplate         Gold overplate         See derating curves         No derating required         Vin = Zero (no power)         Measured at hotspot         External filter is required	-40 -55 105	1.51         47         2.4         68         0.04 & 0.062         1.016 & 1.575         Copper alloy         100-299         3.9-19.6         Aluminum         110         B	110 125 125	Ounces Grams Ounces Grams Inches mm µ-inches µ-inches µ-inches °C °C °C °C °C °C °C Class Class
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material ENVIRONMENTAL Operating Ambient Temperature Range Operating Case Temperature Storage Temperature Thermal Protection/Shutdown Electromagnetic Interference Conducted, EN55022/CISPR22 Relative humidity, non-condensing	No baseplate         With baseplate         With baseplate         With baseplate         Nickel subplate         Gold overplate         See derating curves         No derating required         Vin = Zero (no power)         Measured at hotspot         External filter is required         To +85°C	-40 -55 105 10 -500	1.51         47         2.4         68         0.04 & 0.062         1.016 & 1.575         Copper alloy         100-299         3.9-19.6         Aluminum         110         B	110 125 125 90 10,000	Ounces Grams Ounces Grams Inches mm µ-inches µ-inches µ-inches °C °C °C °C °C °C °C °C Class Class Class Class %RH feet
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material ENVIRONMENTAL Operating Ambient Temperature Range Operating Case Temperature Storage Temperature Thermal Protection/Shutdown Electromagnetic Interference Conducted, EN55022/CISPR22 Relative humidity, non-condensing Altitude	No baseplate         With baseplate         With baseplate         With baseplate         Nickel subplate         Gold overplate         See derating curves         No derating required         Vin = Zero (no power)         Measured at hotspot         External filter is required         To +85°C	-40 -55 105 105 10 -500 -152	1.51         47         2.4         68         0.04 & 0.062         1.016 & 1.575         Copper alloy         100-299         3.9-19.6         Aluminum         110         B	110 125 125 90	Ounces Grams Ounces Grams Inches mm µ-inches µ-inches µ-inches °C °C °C °C °C °C °C °C Class Class Class Class KRH feet meters
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material ENVIRONMENTAL Operating Ambient Temperature Range Operating Case Temperature Storage Temperature Thermal Protection/Shutdown Electromagnetic Interference Conducted, EN55022/CISPR22 Radiated, EN55022/CISPR22 Relative humidity, non-condensing Altitude Acceleration	No baseplate         With baseplate         With baseplate         With baseplate         Nickel subplate         Gold overplate         See derating curves         No derating required         Vin = Zero (no power)         Measured at hotspot         External filter is required         To +85°C         must derate -1%/1000 feet	-40 -55 105 105 -10 -500 -152 50	1.51         47         2.4         68         0.04 & 0.062         1.016 & 1.575         Copper alloy         100-299         3.9-19.6         Aluminum         110         B	110 125 125 90 10,000	Ounces Grams Ounces Grams Inches mm µ-inches µ-inches µ-inches °C °C °C °C °C °C °C °C °C °C °C °C °C
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material ENVIRONMENTAL Operating Ambient Temperature Range Operating Case Temperature Storage Temperature Thermal Protection/Shutdown Electromagnetic Interference Conducted, EN55022/CISPR22 Radiated, EN55022/CISPR22 Relative humidity, non-condensing Altitude Acceleration Shock	No baseplate         With baseplate         With baseplate         With baseplate         Nickel subplate         Gold overplate         See derating curves         No derating required         Vin = Zero (no power)         Measured at hotspot         External filter is required         To +85°C         must derate -1%/1000 feet         Halfsine wave, 3 axes	-40 -55 105 105 10 -500 -152	1.51         47         2.4         68         0.04 & 0.062         1.016 & 1.575         Copper alloy         100-299         3.9-19.6         Aluminum         110         B	110 125 125 90 10,000	Ounces Grams Ounces Grams Inches mm µ-inches µ-inches µ-inches °C °C °C °C °C °C °C °C Class Class Class Class KRH feet meters
Through Hole Pin Diameter Through Hole Pin Material TH Pin Plating Metal and Thickness Baseplate Material ENVIRONMENTAL Operating Ambient Temperature Range Operating Case Temperature Storage Temperature Thermal Protection/Shutdown Electromagnetic Interference Conducted, EN55022/CISPR22 Radiated, EN55022/CISPR22 Relative humidity, non-condensing Altitude Acceleration	No baseplate         With baseplate         With baseplate         With baseplate         Nickel subplate         Gold overplate         See derating curves         No derating required         Vin = Zero (no power)         Measured at hotspot         External filter is required         To +85°C         must derate -1%/1000 feet	-40 -55 105 105 -10 -500 -152 50	1.51         47         2.4         68         0.04 & 0.062         1.016 & 1.575         Copper alloy         100-299         3.9-19.6         Aluminum         110         B	110 125 125 90 10,000	Ounces Grams Ounces Grams Inches mm µ-inches µ-inches µ-inches °C °C °C °C °C °C °C °C °C °C °C °C °C

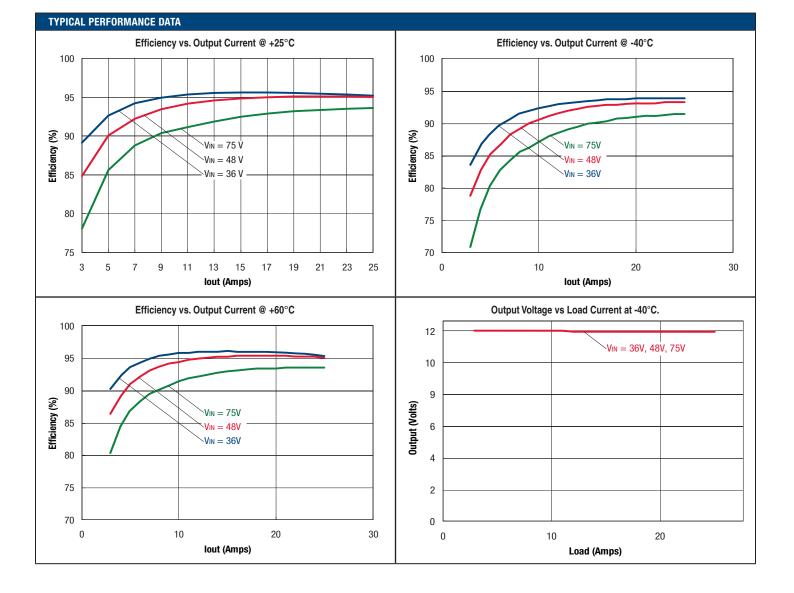
# HPQ-12/25-D48 Series

## Isolated 300-Watt Quarter Brick DC-DC Converters

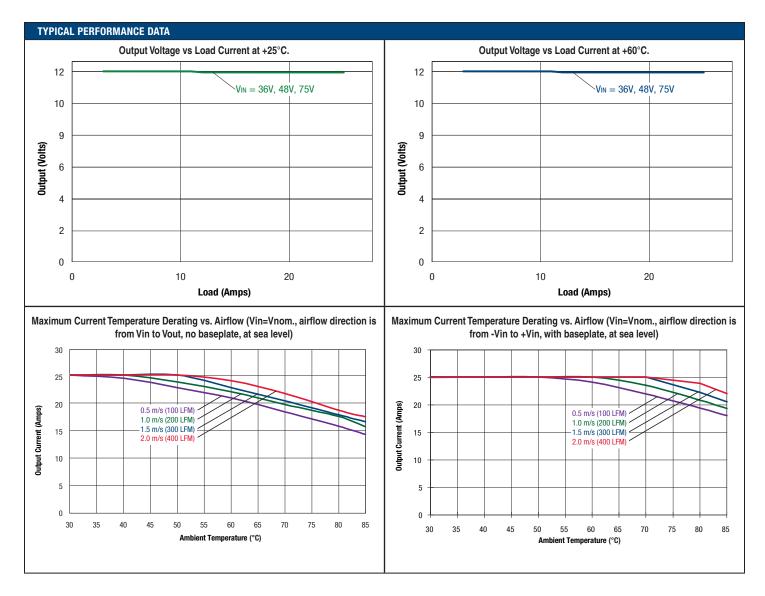
#### **Notes**

- ⑦ Unless otherwise noted, all specifications apply over the input voltage range, full temperature range, nominal output voltage and full output load. General conditions are near sea level altitude, no base plate installed and natural convection airflow unless otherwise specified. All models are tested and specified with external parallel 1 µF and 10 µF multi-layer ceramic output capacitors. No external input capacitor is used (see Application Notes). All capacitors are low-ESR types wired close to the converter. These capacitors are necessary for our test equipment and may not be needed in the user's application.
- @ Input (back) ripple current is tested and specified over 5 Hz to 20 MHz bandwidth. Input filtering is Cin = 33  $\mu\text{F}$ , Cbus = 220 $\mu\text{F}$  and Lbus = 4.7  $\mu\text{H}.$
- ③ All models are stable and regulate to specification under no load.
- ④ The Remote On/Off Control is referred to -Vin.
- ⑤ Regulation specifications describe the output voltage changes as the line voltage or load current is varied from its nominal or midpoint value to either extreme. The load step is ±25% of full load current.
- ③ Output Ripple and Noise is measured with Cout = 1µF MLCC paralleled with 10µF tantalum, 20 MHz oscilloscope bandwidth and full resistive load.

- ⑦ The Sense and Trim pins are removed for the "X" model option.
- INOTICE—Please use only this customer data sheet as product documentation when laying out your printed circuit boards and applying this product into your application. Do NOT use other materials as official documentation such as advertisements, product announcements, or website graphics. We strive to have all technical data in this customer data sheet highly accurate and complete. This customer data sheet is revision-controlled and dated. The latest customer data sheet revision is normally on our website (www.murata-ps.com) for products which are fully released to Manufacturing. Please be especially careful using any data sheets labeled "Preliminary" since data may change without notice. The pinout (Pxx) and case (Cxx) designations (typically P65 or C59) refer to a generic family of closely related information. It may not be a single pinout or unique case outline. Please be aware of small details (such as Sense pins, Power Good pins, etc.) or slightly different dimensions (baseplates, heat sinks, etc.) which may affect your application and PC board layouts. Study the Mechanical Outline drawings, Input/Output Connection table and all footnotes very carefully. Please contact Murata Power Solutions if you have any questions.
- (9) HPQ restart delay (see technical notes, page 12).

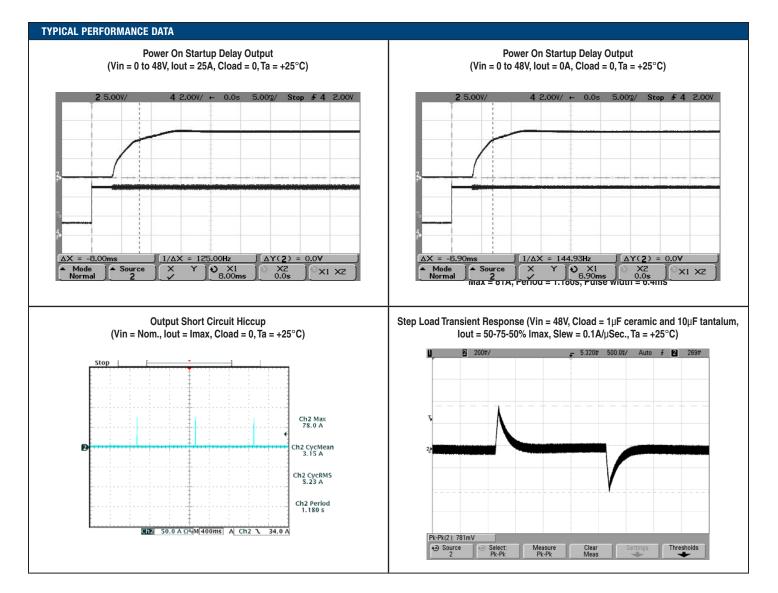


# HPQ-12/25-D48 Series

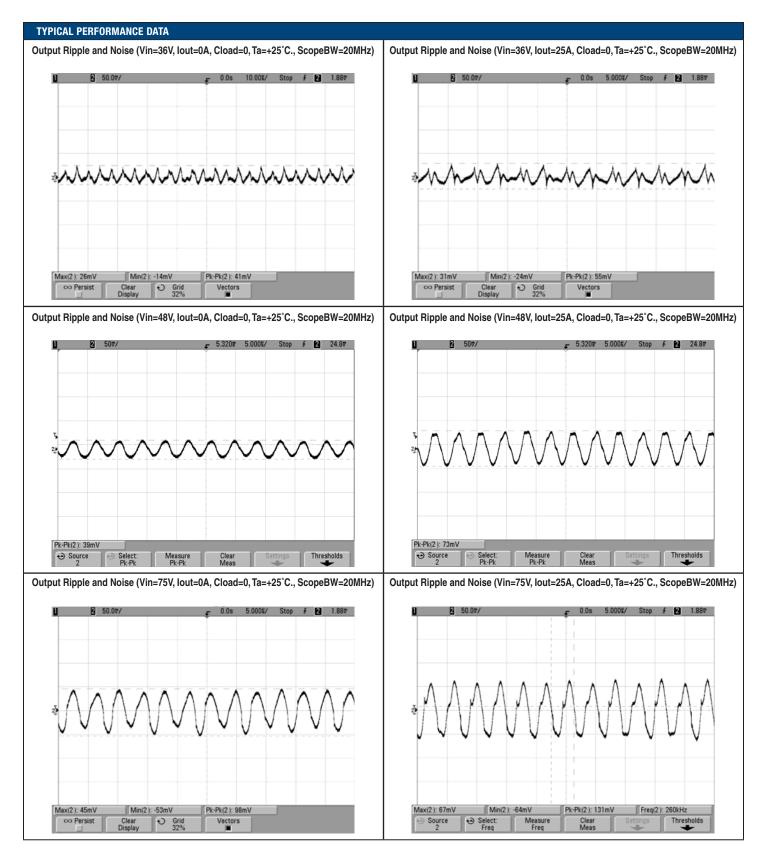




# HPQ-12/25-D48 Series



# HPQ-12/25-D48 Series



# HPQ-12/25-D48 Series

Isolated 300-Watt Quarter Brick DC-DC Converters

#### **TYPICAL PERFORMANCE DATA**

#### **HPQ Restart Delay (See Specification Note 9)**

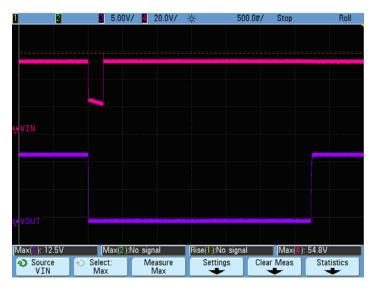
When the HPQ undergoes shutdown through loss or cycling of the input power, a 555 timer enable block circuit is triggered to provide a restart delay to assure systematic restart of the converter. The delay time is a function both of the recovery time of the input voltage and the 555 reset time.

Thus, there are two distinct scenarios for the restart delay, which are detailed below.

Scenario I: Vin recovers quickly.

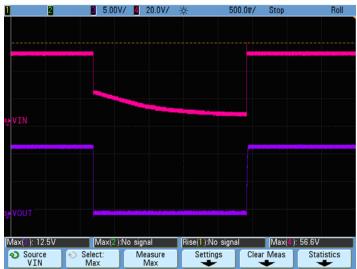
When the input voltage recovers quickly, the Vcc for the 555 timer remains active to lockout the output for the programmed delay time. The delay time in this scenario is then equal to the 555 hiccup recovery time. This is internally set to a nominal value of 3s. This is illustrated in the scope shot below:

Vin (20V per division), Vout (5V per division) at 500ms (1/2 S per division).



Scenario II: Vin recovers after more than 2.5s (restart delay time less than 15ms)

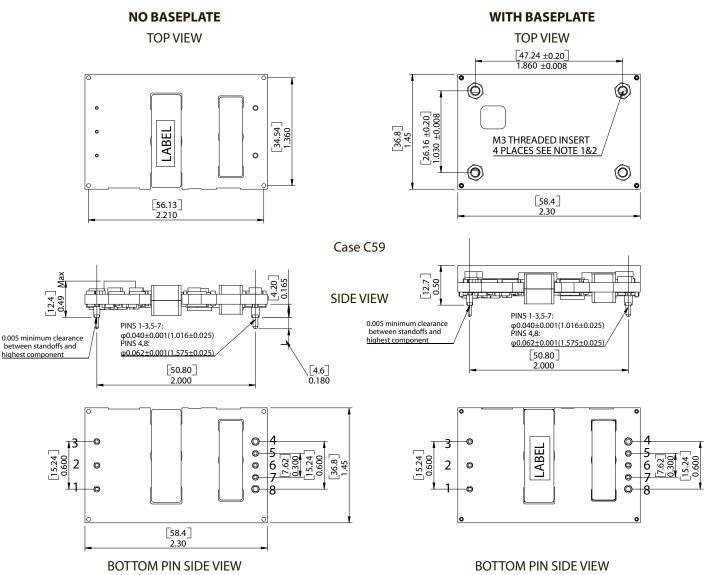
When the input voltage is absent greater than 2.5s, the energy for the Vcc to the 555 timer enable block will be exhausted. Since this is a sufficient period to guarantee systematic restart of the converter, the output will start after just a 15ms delay from the application of input power. This scenario is illustrated in the scope shot below.



## HPQ-12/25-D48 Series

### Isolated 300-Watt Quarter Brick DC-DC Converters

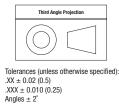
#### MECHANICAL SPECIFICATIONS (THROUGH-HOLE MOUNT)-DOSA COMPLIANT



① M3 bolts must not exceed 0.118" (3mm) depth below the baseplate surface. ② Applied screw torque must not exceed 5.3 in-lb. (0.6 N-m).

The standard 0.180" pin length is shown. Please refer to the part number structure for alternate pin lengths.

Dimensions are in inches (mm shown for ref. only).



Components are shown for reference only.

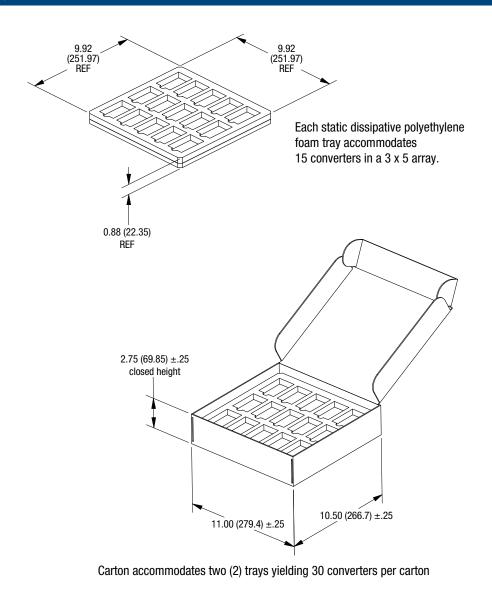
DOSA-Compatible I/O Connections (pin side view)							
Pin	Function P32	Pin	Function P32				
1	Pos. Vin	5	Neg. Sense*				
2	Remote On/Off Control	6	Trim*				
3	Neg. Vin	7	Pos. Sense*				
4	Neg. Output	8	Pos. Output				

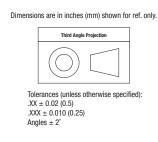
\* The Sense and Trim pins are removed for the "X" model option.



# HPQ-12/25-D48 Series







# HPQ-12/25-D48 Series

#### TECHNICAL NOTES

#### **Input Fusing**

Certain applications and/or safety agencies may require fuses at the inputs of power conversion components. Fuses should also be used when there is the possibility of sustained input voltage reversal which is not current-limited. For greatest safety, we recommend a fast blow fuse installed in the ungrounded input supply line.

The installer must observe all relevant safety standards and regulations. For safety agency approvals, install the converter in compliance with the end-user safety standard.

#### **Input Reverse-Polarity Protection**

If the input voltage polarity is reversed, body diodes of mosfets will become forward biased and likely draw excessive current from the power source. If this source is not current-limited or the circuit appropriately fused, it could cause permanent damage to the converter.

#### Input Under-Voltage Shutdown and Start-Up Threshold

Under normal start-up conditions, converters will not begin to regulate properly until the rising input voltage exceeds and remains at the Start-Up Threshold Voltage (see Specifications). Once operating, converters will not turn off until the input voltage drops below the Under-Voltage Shutdown Limit. Subsequent restart will not occur until the input voltage rises again above the Start-Up Threshold. This built-in hysteresis prevents any unstable on/off operation at a single input voltage.

Users should be aware however of input sources near the Under-Voltage Shutdown whose voltage decays as input current is consumed (such as capacitor inputs), the converter shuts off and then restarts as the external capacitor recharges. Such situations could oscillate. To prevent this, make sure the operating input voltage is well above the UV Shutdown voltage AT ALL TIMES.

#### Start-Up Delay

Assuming that the output current is set at the rated maximum, the Vin to Vout Start-Up Delay (see Specifications) is the time interval between the point when the rising input voltage crosses the Start-Up Threshold and the fully loaded regulated output voltage enters and remains within its specified regulation band. Actual measured times will vary with input source impedance, external input capacitance, input voltage slew rate and final value of the input voltage as it appears at the converter.

These converters include a soft start circuit to moderate the duty cycle of the PWM controller at power up, thereby limiting the input inrush current.

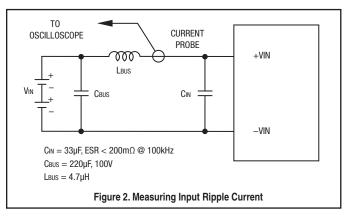
The On/Off Remote Control interval from inception to Vout regulated assumes that the converter already has its input voltage stabilized above the Start-Up Threshold before the On command. The interval is measured from the On command until the output enters 90% of its specified regulation band. The specification assumes that the output is fully loaded at maximum rated current.

#### Input Source Impedance

These converters will operate to specifications without external components, assuming that the source voltage has very low impedance and reasonable input voltage regulation. Since real-world voltage sources have finite impedance, performance is improved by adding external filter components. Sometimes only a small ceramic capacitor is sufficient. Since it is difficult to totally characterize all applications, some experimentation may be needed. Note that external input capacitors must accept high speed switching currents. Because of the switching nature of DC/DC converters, the input of these converters must be driven from a source with both low AC impedance and adequate DC input regulation. Performance will degrade with increasing input inductance. Excessive input inductance may inhibit operation. The DC input regulation specifies that the input voltage, once operating, must never degrade below the Shut-Down Threshold under all load conditions. Be sure to use adequate trace sizes and mount components close to the converter.

#### I/O Filtering, Input Ripple Current and Output Noise

All models in this converter series are tested and specified for input reflected ripple current and output noise using designated external input/output components, circuits and layout as shown in the figures below. External input capacitors (CN in the figure) serve primarily as energy storage elements, minimizing line voltage variations caused by transient IR drops in the input conductors. Users should select input capacitors for bulk capacitance (at appropriate frequencies), low ESR and high RMS ripple current ratings. In the figure below, the CBUS and LBUS components simulate a typical DC voltage bus. Your specific system configuration may require additional considerations. Please note that the values of CIN, LBUS and CBUS may vary according to the specific converter model.



In critical applications, output ripple and noise (also referred to as periodic and random deviations or PARD) may be reduced by adding filter elements such as multiple external capacitors. Be sure to calculate component temperature rise from reflected AC current dissipated inside capacitor ESR.

#### **Floating Outputs**

Since these are isolated DC/DC converters, their outputs are "floating" with respect to their input. The essential feature of such isolation is ideal ZERO CURRENT FLOW between input and output. Real-world converters however do exhibit tiny leakage currents between input and output (see Specifications). These leakages consist of both an AC stray capacitance coupling component and a DC leakage resistance. When using the isolation feature, do not allow the isolation voltage to exceed specifications. Otherwise the converter may be damaged. Designers will normally use the negative output (-Output) as the ground return of the load circuit. You can however use the positive output (+Output) as the ground return to effectively reverse the output polarity.

#### **Minimum Output Loading Requirements**

These converters employ a synchronous rectifier design topology. All models regulate within specification and are stable under no load to full load conditions.

## 

#### **Thermal Shutdown**

To protect against thermal over-stress, these converters include thermal shutdown circuitry. If environmental conditions cause the temperature of the DC/ DC's to rise above the Operating Temperature Range up to the shutdown temperature, an on-board electronic temperature sensor will power down the unit. When the temperature decreases below the turn-on threshold, the converter will automatically restart. There is a small amount of hysteresis to prevent rapid on/off cycling. CAUTION: If you operate too close to the thermal limits, the converter may shut down suddenly without warning. Be sure to thoroughly test your application to avoid unplanned thermal shutdown.

#### **Temperature Derating Curves**

The graphs in this data sheet illustrate typical operation under a variety of conditions. The Derating curves show the maximum continuous ambient air temperature and decreasing maximum output current which is acceptable under increasing forced airflow measured in Linear Feet per Minute ("LFM"). Note that these are AVERAGE measurements. The converter will accept brief increases in temperature and/or current or reduced airflow as long as the average is not exceeded.

Note that the temperatures are of the ambient airflow, not the converter itself which is obviously running at higher temperature than the outside air. Also note that "natural convection" is defined as very low flow rates which are not using fan-forced airflow. Depending on the application, "natural convection" is usually about 30-65 LFM but is not equal to still air (0 LFM).

Murata Power Solutions makes Characterization measurements in a closed cycle wind tunnel with calibrated airflow. We use both thermocouples and an infrared camera system to observe thermal performance. As a practical matter, it is quite difficult to insert an anemometer to precisely measure airflow in most applications. Sometimes it is possible to estimate the effective airflow if you thoroughly understand the enclosure geometry, entry/exit orifice areas and the fan flowrate specifications.

CAUTION: If you exceed these Derating guidelines, the converter may have an unplanned Over Temperature shut down. Also, these graphs are all collected near Sea Level altitude. Be sure to reduce the derating for higher altitude.

#### **Output Overvoltage Protection (OVP)**

This converter monitors its output voltage for an over-voltage condition using an on-board electronic comparator. The signal is optically coupled to the pri-

## Isolated 300-Watt Quarter Brick DC-DC Converters

HPQ-12/25-D48 Series

mary side PWM controller. If the output exceeds OVP limits, the sensing circuit will power down the unit, and the output voltage will decrease. After a time-out period, the PWM will automatically attempt to restart, causing the output voltage to ramp up to its rated value. It is not necessary to power down and reset the converter for this automatic OVP-recovery restart.

If the fault condition persists and the output voltage climbs to excessive levels, the OVP circuitry will initiate another shutdown cycle. This on/off cycling is referred to as "hiccup" mode.

#### **Output Fusing**

The converter is extensively protected against current, voltage and temperature extremes. However, your application circuit may need additional protection. In the extremely unlikely event of output circuit failure, excessive voltage could be applied to your circuit. Consider using an appropriate external protection.

#### **Output Current Limiting**

As soon as the output current increases to approximately its overcurrent limit, the DC/DC converter will enter a current-limiting mode. The output voltage will decrease proportionally with increases in output current.

Current limiting inception is defined as the point at which full power falls below the rated tolerance. See the Performance/Functional Specifications. Note particularly that the output current may briefly rise above its rated value. This enhances reliability and continued operation of your application. If the output current is too high, the converter will enter the short circuit condition.

#### **Output Short Circuit Condition**

When a converter is in current-limit mode, the output voltage will drop as the output current demand increases. If the output voltage drops too low, the magnetically coupled voltage used to develop PWM bias voltage will also drop, thereby shutting down the PWM controller. Following a time-out period, the PWM will restart, causing the output voltage to begin rising to its appropriate value. If the short-circuit condition persists, another shutdown cycle will initiate. This on/off cycling is called "hiccup mode." The hiccup cycling reduces the average output current, thereby preventing excessive internal temperatures.

#### Trimming the Output Voltage (See Specification Note 7)

The Trim input to the converter allows the user to adjust the output voltage over the rated trim range (please refer to the Specifications). In the trim equations and circuit diagrams that follow, trim adjustments use a single fixed resistor connected between the Trim input and either Vout pin. Trimming resistors should have a low temperature coefficient (±100 ppm/deg.C or less) and be mounted close to the converter. Keep leads short. If the trim function is not used, leave the trim unconnected. With no trim, the converter will exhibit its specified output voltage accuracy.

There are two CAUTIONs to observe for the Trim input:

<u>CAUTION</u>: To avoid unplanned power down cycles, do not exceed EITHER the maximum output voltage OR the maximum output power when setting the trim. If the output voltage is excessive, the OVP circuit may inadvertantly shut down the converter. If the maximum power is exceeded, the converter may enter current limiting. If the power is exceeded for an extended period, the converter may overheat and encounter overtemperature shut down.



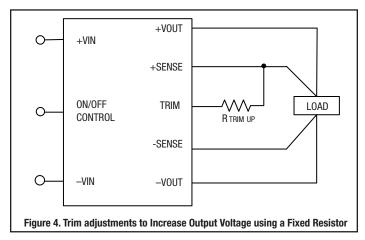
## HPQ-12/25-D48 Series

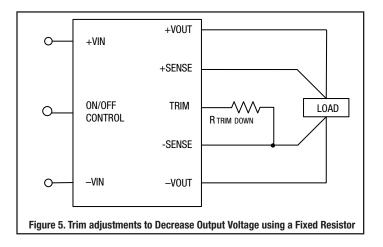
<u>CAUTION</u>: Be careful of external electrical noise. The Trim input is a senstive input to the converter's feedback control loop. Excessive electrical noise may cause instability or oscillation. Keep external connections short to the Trim input. Use shielding if needed.

#### **Trim Equations**

$$R_{adj\_up} (in k\Omega) = 5.11 x \left[ \frac{12V \times (1+\Delta)}{1.225 \times \Delta} - \frac{1}{\Delta} - 2 \right]$$
  
where  $\Delta = \frac{V_{out} - 12V}{12V}$   
$$R_{adj\_down} (in k\Omega) = 5.11 x \left[ \frac{1}{\Delta} - 2 \right]$$
  
where  $\Delta = \frac{12V - V_{out}}{12V}$ 

Where Vout = Desired output voltage. Adjustment accuracy is subject to resistor tolerances and factory-adjusted output accuracy. Mount trim resistor close to converter. Use short leads. Note that " $\Delta$ " is given as a small fraction, not a percentage.





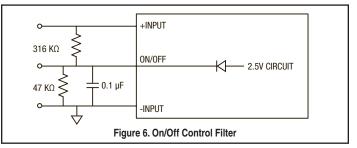
## Isolated 300-Watt Quarter Brick DC-DC Converters

#### **Remote On/Off Control**

On the input side, a remote On/Off Control can be specified with either positive or negative logic as follows:

<u>Positive</u>: Models equipped with Positive Logic are enabled when the On/Off pin is left open or is pulled high to +13.5Vpc with respect to  $-V_{IN}$ . An internal bias current causes the open pin to rise to  $+V_{IN}$ . Positive-logic devices are disabled when the On/Off is grounded or brought to within a low voltage (see Specifications) with respect to  $-V_{IN}$ .

On positive-logic models, to reduce noise coupling on the external on/off control, use the circuit shown in figure 6.



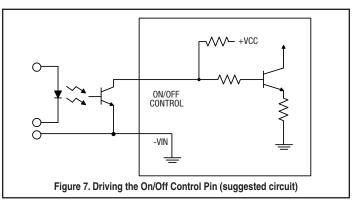
<u>Negative:</u> Models with negative logic are on (enabled) when the On/Off is grounded or brought to within a low voltage (see Specifications) with respect to  $-V_{IN}$ . The device is off (disabled) when the On/Off is left open or is pulled high to  $+13.5V_{DC}$  Max. with respect to  $-V_{IN}$ .

Dynamic control of the On/Off function should be able to sink the specified signal current when brought low and withstand specified voltage when brought high. Be aware too that there is a finite time in milliseconds (see Specifications) between the time of On/Off Control activation and stable, regulated output. This time will vary slightly with output load type and current and input conditions.

There are two CAUTIONs for the On/Off Control:

<u>CAUTION:</u> While it is possible to control the On/Off with external logic if you carefully observe the voltage levels, the preferred circuit is either an open drain/open collector transistor or a relay (which can thereupon be controlled by logic). The On/Off prefers to be set at approx. +13.5V (open pin) for the ON state, assuming positive logic.

<u>CAUTION:</u> Do not apply voltages to the On/Off pin when there is no input power voltage. Otherwise the converter may be permanently damaged.



# HPQ-12/25-D48 Series

#### Remote Sense Input (See Specification Note 7)

Sense inputs compensate for output voltage inaccuracy delivered at the load. This is done by correcting voltage drops along the output wiring such as moderate IR drops and the current carrying capacity of PC board etch. Sense inputs also improve the stability of the converter and load system by optimizing the control loop phase margin.

Note: The Sense input and power Vout lines are internally connected through low value resistors to their respective polarities so that the converter can operate without external connection to the Sense. Nevertheless, if the Sense function is not used for remote regulation, the user should connect +Sense to +Vout and -Sense to -Vout at the converter pins.

The remote Sense lines carry very little current. They are also capacitively coupled to the output lines and therefore are in the feedback control loop to regulate and stabilize the output. As such, they are not low impedance inputs and must be treated with care in PC board layouts. Sense lines on the PCB should run adjacent to DC signals, preferably Ground. In cables and discrete wiring, use twisted pair, shielded tubing or similar techniques

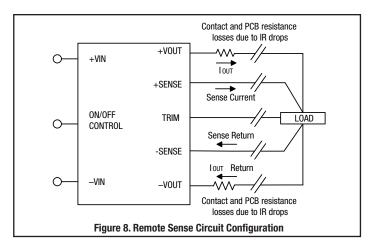
Please observe Sense inputs tolerance to avoid improper operation:

#### $[Vout(+) - Vout(-)] - [Sense(+) - Sense(-)] \le 10\%$ of Vout

Output overvoltage protection is monitored at the output voltage pin, not the Sense pin. Therefore excessive voltage differences between Vout and Sense together with trim adjustment of the output can cause the overvoltage protection circuit to activate and shut down the output.

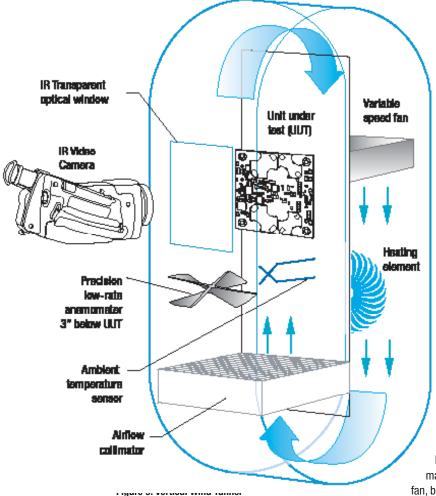
Power derating of the converter is based on the combination of maximum output current and the highest output voltage. Therefore the designer must ensure:

(Vout at pins) x (lout)  $\leq$  (Max. rated output power)



# HPQ-12/25-D48 Series

Isolated 300-Watt Quarter Brick DC-DC Converters



#### **Vertical Wind Tunnel**

Murata Power Solutions employs a computer controlled custom-designed closed loop vertical wind tunnel, infrared video camera system, and test instrumentation for accurate airflow and heat dissipation analysis of power products. The system includes a precision low flow-rate anemometer, variable speed fan, power supply input and load controls, temperature gauges, and adjustable heating element.

The IR camera monitors the thermal performance of the Unit Under Test (UUT) under static steady-state conditions. A special optical port is used which is transparent to infrared wavelengths.

Both through-hole and surface mount converters are soldered down to a 10" X10" host carrier board for realistic heat absorption and spreading. Both longitudinal and transverse airflow studies are possible by rotation of this carrier board since there are often significant differences in the heat dissipation in the two airflow directions. The combination of adjustable airflow, adjustable ambient heat, and adjustable Input/Output currents and voltages mean that a very wide range of measurement conditions can be studied.

The collimator reduces the amount of turbulence adjacent to the UUT by minimizing airflow turbulence. Such turbulence influences the effective heat transfer characteristics and gives false readings. Excess turbulence removes more heat from some surfaces and less heat from others, possibly causing uneven overheating.

Both sides of the UUT are studied since there are different thermal gradients on each side. The adjustable heating element and fan, built-in temperature gauges, and no-contact IR camera mean that power supplies are tested in real-world conditions.

#### **Soldering Guidelines**

Murata Power Solutions recommends the specifications below when installing these converters. These specifications vary depending on the solder type. Exceeding these specifications may cause damage to the product. Your production environment may differ; therefore please thoroughly review these guidelines with your process engineers.

Wave Solder Operations for through-hole mounted products (THMT)								
For Sn/Ag/Cu based solders:		For Sn/Pb based solders:						
Maximum Preheat Temperature	115° C.	Maximum Preheat Temperature	105° C.					
Maximum Pot Temperature	270° C.	Maximum Pot Temperature	250° C.					
Maximum Solder Dwell Time 7 seconds Maximum Solder Dwell Time 6 seconds								

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